- The correlation between Log r<sub>|qmw</sub>from TVIS vial and the thermoccuple temperature in a neighboring vial of the re-heating part of annealing step (Fig.2A) provides a predictive product temperature at primary drying process defined as T-FPEAK (Fig.2B).
- The decrease in Opr9TJ 1.853 0 Td (and) ij 2.0-0.(and) Tj 2.0-0.(and) (rre)-3.50 2767.5571 T3Ty2.0-0.(andn) Tj Ea0(ea)